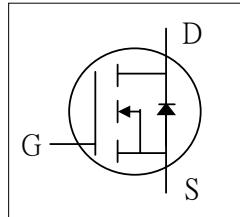




▼ 100% Avalanche Test

▼ Fast Switching

▼ Simple Drive Requirement

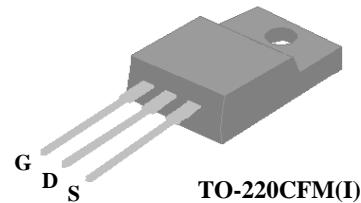


|              |       |
|--------------|-------|
| $BV_{DSS}$   | 650V  |
| $R_{DS(ON)}$ | 0.75Ω |
| $I_D$        | 9A    |

## Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220CFM isolation package is widely preferred for all commercial-industrial through hole applications.



## Absolute Maximum Ratings

| Symbol                    | Parameter                                  | Rating     | Units |
|---------------------------|--|------------|-------|
| $V_{DS}$                  | Drain-Source Voltage                       | 650        | V     |
| $V_{GS}$                  | Gate-Source Voltage                        | $\pm 30$   | V     |
| $I_D @ T_C = 25^\circ C$  | Continuous Drain Current, $V_{GS} @ 10V$   | 9          | A     |
| $I_D @ T_C = 100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$   | 5          | A     |
| $I_{DM}$                  | Pulsed Drain Current <sup>1</sup>          | 40         | A     |
| $P_D @ T_C = 25^\circ C$  | Total Power Dissipation                    | 42         | W     |
|                           | Linear Derating Factor                     | 0.34       | W/°C  |
| $E_{AS}$                  | Single Pulse Avalanche Energy <sup>2</sup> | 40.5       | mJ    |
| $I_{AR}$                  | Avalanche Current                          | 9          | A     |
| $T_{STG}$                 | Storage Temperature Range                  | -55 to 150 | °C    |
| $T_J$                     | Operating Junction Temperature Range       | -55 to 150 | °C    |

## Thermal Data

| Symbol      | Parameter                                    | Value | Units |
|-------------|--|-------|-------|
| $R_{thj-c}$ | Maximum Thermal Resistance, Junction-case    | 3     | °C/W  |
| $R_{thj-a}$ | Maximum Thermal Resistance, Junction-ambient | 65    | °C/W  |



### Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol                                     | Parameter  | Test Conditions   | Min. | Typ. | Max.      | Units                     |
|--|--|---|------|------|-----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                           | $\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_D=1\text{mA}$                | 650  | -    | -         | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient                | Reference to $25^\circ\text{C}$ , $\text{I}_D=1\text{mA}$                 | -    | 0.6  | -         | $\text{V}/^\circ\text{C}$ |
| $\text{R}_{\text{DS(ON)}}$                 | Static Drain-Source On-Resistance <sup>3</sup>           | $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=4.5\text{A}$              | -    | -    | 0.75      | $\Omega$                  |
| $\text{V}_{\text{GS(th)}}$                 | Gate Threshold Voltage                                   | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$ , $\text{I}_D=250\mu\text{A}$ | 2    | -    | 4         | V                         |
| $\text{g}_{\text{fs}}$                     | Forward Transconductance                                 | $\text{V}_{\text{DS}}=50\text{V}$ , $\text{I}_D=4.5\text{A}$              | -    | 4.5  | -         | S                         |
| $\text{I}_{\text{DSS}}$                    | Drain-Source Leakage Current                             | $\text{V}_{\text{DS}}=600\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$     | -    | -    | 10        | $\mu\text{A}$             |
|  | Drain-Source Leakage Current ( $T_j=125^\circ\text{C}$ ) | $\text{V}_{\text{DS}}=480\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$     | -    | -    | 500       | $\mu\text{A}$             |
| $\text{I}_{\text{GSS}}$                    | Gate-Source Leakage                                      | $\text{V}_{\text{GS}}=\pm 30\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$  | -    | -    | $\pm 100$ | $\text{nA}$               |
| $\text{Q}_g$                               | Total Gate Charge <sup>3</sup>                           | $\text{I}_D=9\text{A}$  | -    | 44   | -         | nC                        |
| $\text{Q}_{\text{gs}}$                     | Gate-Source Charge                                       | $\text{V}_{\text{DS}}=480\text{V}$  | -    | 11   | -         | nC                        |
| $\text{Q}_{\text{gd}}$                     | Gate-Drain ("Miller") Charge                             | $\text{V}_{\text{GS}}=10\text{V}$   | -    | 12   | -         | nC                        |
| $t_{\text{d(on)}}$                         | Turn-on Delay Time <sup>3</sup>                          | $\text{V}_{\text{DD}}=300\text{V}$  | -    | 19   | -         | ns                        |
| $t_r$                                      | Rise Time  | $\text{I}_D=9\text{A}$  | -    | 21   | -         | ns                        |
| $t_{\text{d(off)}}$                        | Turn-off Delay Time                                      | $\text{R}_G=10\Omega$ , $\text{V}_{\text{GS}}=10\text{V}$                 | -    | 56   | -         | ns                        |
| $t_f$                                      | Fall Time  | $\text{R}_D=34\Omega$   | -    | 24   | -         | ns                        |
| $C_{\text{iss}}$                           | Input Capacitance  | $\text{V}_{\text{GS}}=0\text{V}$  | -    | 2660 | -         | pF                        |
| $C_{\text{oss}}$                           | Output Capacitance                                       | $\text{V}_{\text{DS}}=25\text{V}$   | -    | 170  | -         | pF                        |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                             | f=1.0MHz  | -    | 10   | -         | pF                        |

### Source-Drain Diode

| Symbol                 | Parameter   | Test Conditions  | Min. | Typ. | Max. | Units |
|------------------------|---|--|------|------|------|-------|
| $\text{I}_S$           | Continuous Source Current ( Body Diode )          | $\text{V}_D=\text{V}_G=0\text{V}$ , $\text{V}_S=1.5\text{V}$                       | -    | -    | 9    | A     |
| $\text{I}_{\text{SM}}$ | Pulsed Source Current ( Body Diode ) <sup>1</sup> |  | -    | -    | 40   | A     |
| $\text{V}_{\text{SD}}$ | Forward On Voltage <sup>3</sup>                   | $T_j=25^\circ\text{C}$ , $\text{I}_S=9\text{A}$ , $\text{V}_{\text{GS}}=0\text{V}$ | -    | -    | 1.5  | V     |

#### Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Starting  $T_j=25^\circ\text{C}$  ,  $\text{V}_{\text{DD}}=50\text{V}$  ,  $\text{L}=1\text{mH}$  ,  $\text{R}_G=25\Omega$  ,  $\text{I}_{\text{AS}}=9\text{A}$ .
- 3.Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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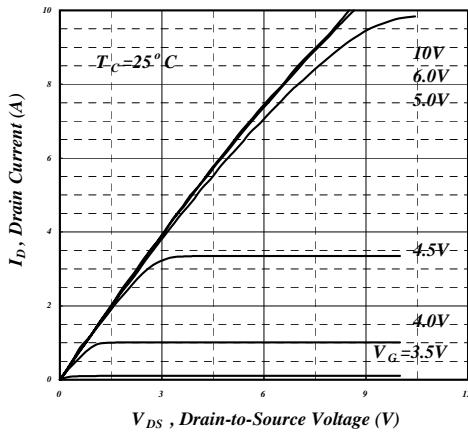


Fig 1. Typical Output Characteristics

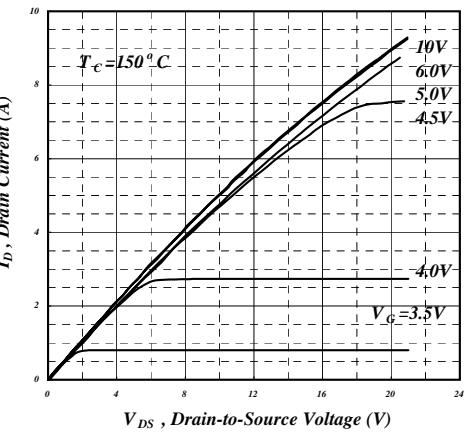


Fig 2. Typical Output Characteristics

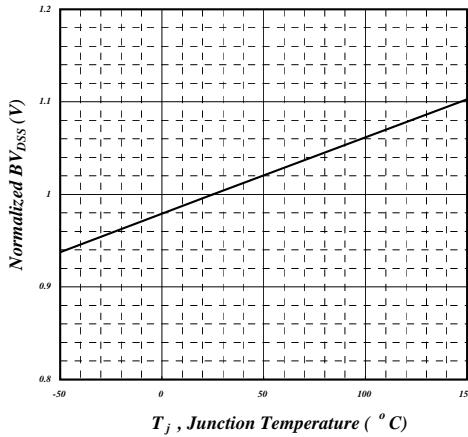
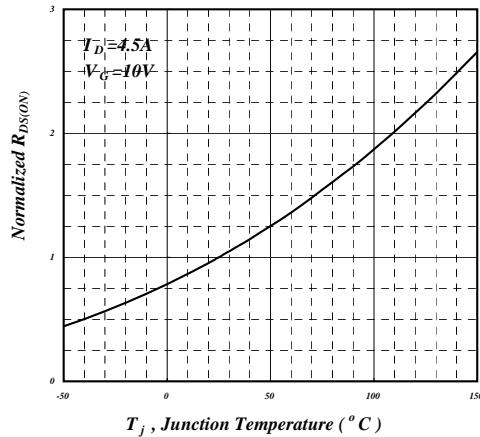
Fig 3. Normalized  $BV_{DSS}$  v.s. Junction Temperature

Fig 4. Normalized On-Resistance v.s. Junction Temperature

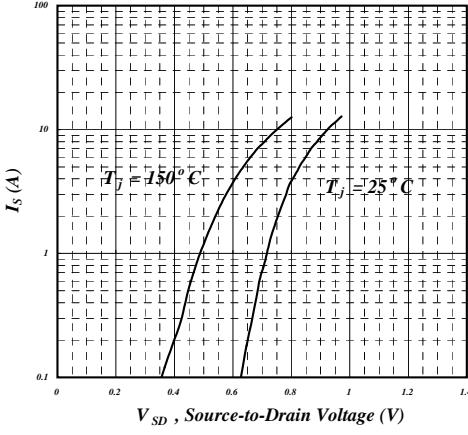


Fig 5. Forward Characteristic of Reverse Diode

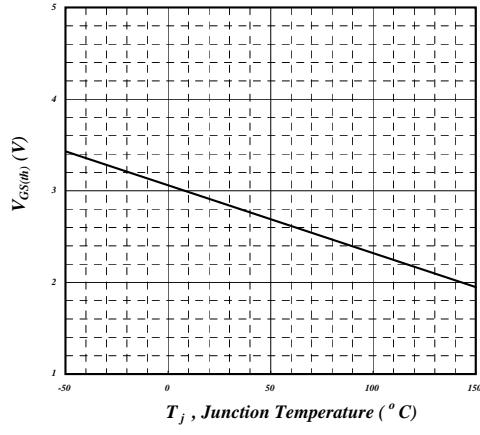


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



## AP09N70I-A

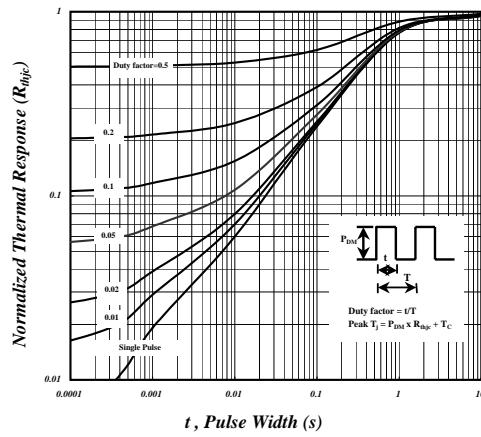
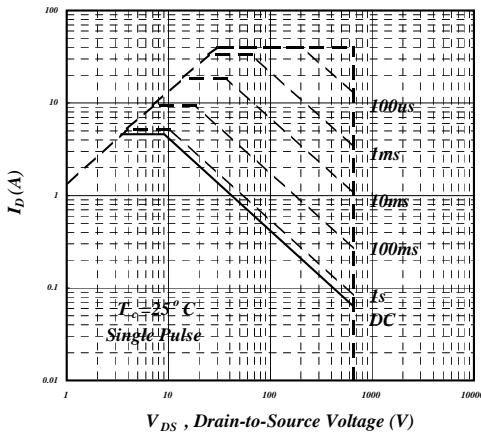
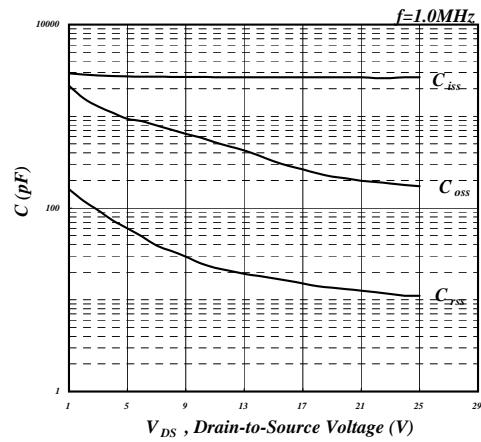
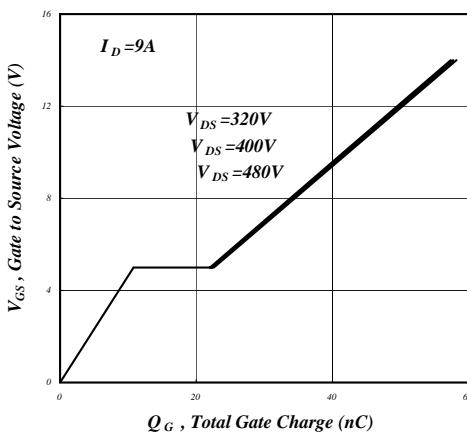


Fig 9. Maximum Safe Operating Area

Fig 10. Effective Transient Thermal Impedance

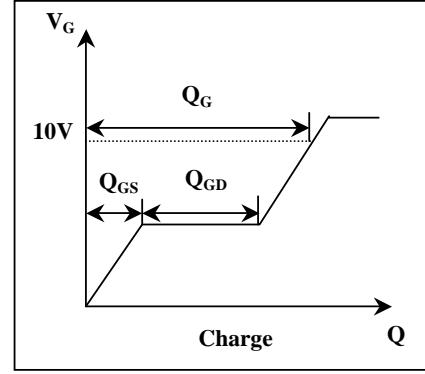
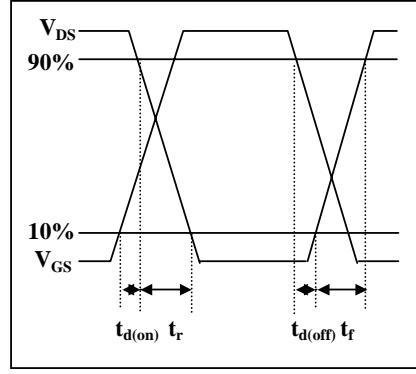


Fig 11. Switching Time Waveform

Fig 12. Gate Charge Waveform